

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Virgil Cotoco Ararao, et al. : Confirmation No.: 6546
Serial No.: 10/721,916 : Art Unit: 2813
Filed: 11/24/2003 : Examiner: Thanh T. Nguyen
For: FABRICATION METHOD :
FOR SEMICONDUCTOR
PACKAGE HEAT
SPREADERS

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE AFTER FINAL REJECTION

Sir/Madam:

The following Remarks are submitted in response to the Final Office Action mailed January 29, 2007. After this introductory section, there are Remarks starting on a separate page.

Reconsideration of the rejections is respectfully requested.